



US00D852775S

(12) **United States Design Patent**  
**Ando et al.**

(10) **Patent No.:** **US D852,775 S**  
(45) **Date of Patent:** **\*\* Jul. 2, 2019**

(54) **HEADPHONE**

(71) Applicant: **AUDIO-TECHNICA CORPORATION, Tokyo (JP)**

(72) Inventors: **Kozo Ando, Kanagawa (JP); Shohei Araki, Kanagawa (JP)**

(73) Assignee: **AUDIO-TECHNICA CORPORATION, Tokyo (JP)**

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/592,314**

(22) Filed: **Jan. 30, 2017**

(30) **Foreign Application Priority Data**

Aug. 2, 2016 (JP) ..... 2016-016537

(51) **LOC (11) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
USPC ..... **D14/205**

(58) **Field of Classification Search**

USPC ..... D14/205, 223, 188, 192; D29/112;  
2/209; 181/129, 130, 135; 379/430, 431;  
381/380, 381, 374; 455/90.3, 575.1,  
455/569.1

CPC .... H04R 25/00; H04R 1/1066; H04R 1/1016;  
H04R 5/033; H04R 5/0335; H04R 25/02;  
H04R 1/02

See application file for complete search history.

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

4,429,194 A \* 1/1984 Kamon ..... H04R 1/1016  
381/371  
4,646,872 A \* 3/1987 Kamon ..... H04R 1/225  
181/129

D337,589 S \* 7/1993 Wada ..... D14/223  
D342,739 S \* 12/1993 Atkin ..... D14/217  
D353,379 S \* 12/1994 Nakamura ..... D14/223  
5,420,935 A \* 5/1995 Shinohara ..... H04R 1/1016  
379/431  
D485,548 S \* 1/2004 Obata ..... D14/223  
D487,077 S \* 2/2004 Obata ..... D14/223  
D556,741 S \* 12/2007 Yeo ..... D14/205  
D718,284 S \* 11/2014 Shibusawa ..... D14/223  
8,879,768 B2 \* 11/2014 Podoloff ..... H04R 1/1016  
381/370  
D746,268 S \* 12/2015 Karayiannis ..... D14/223  
2007/0154050 A1 \* 7/2007 Kim ..... H04R 1/1041  
381/382  
2011/0305360 A1 \* 12/2011 Tung ..... H04R 1/1041  
381/370

\* cited by examiner

*Primary Examiner* — Paula Allen Greene

(74) *Attorney, Agent, or Firm* — W & C IP

(57) **CLAIM**

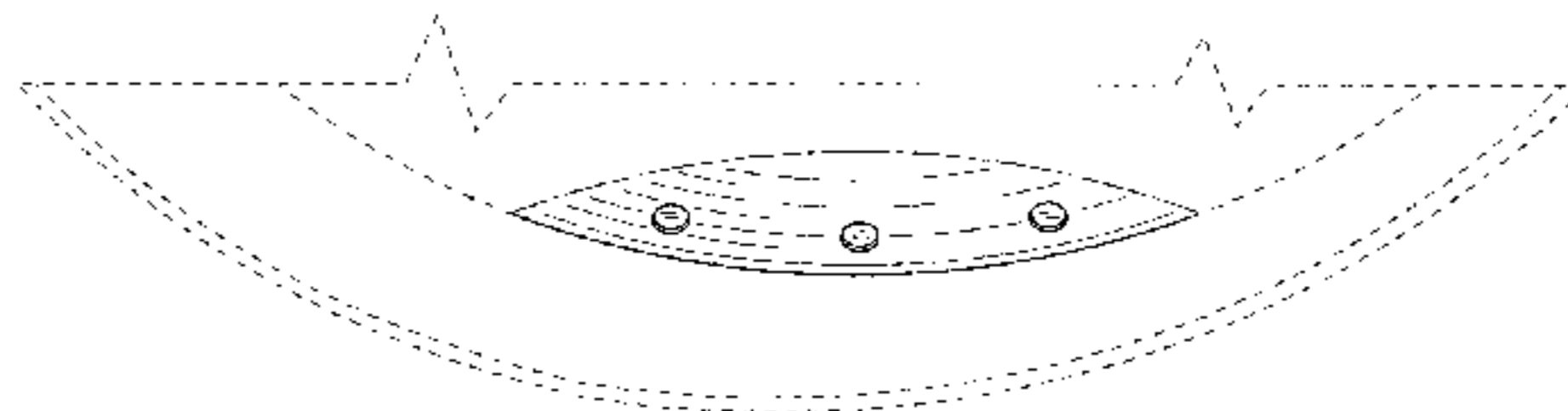
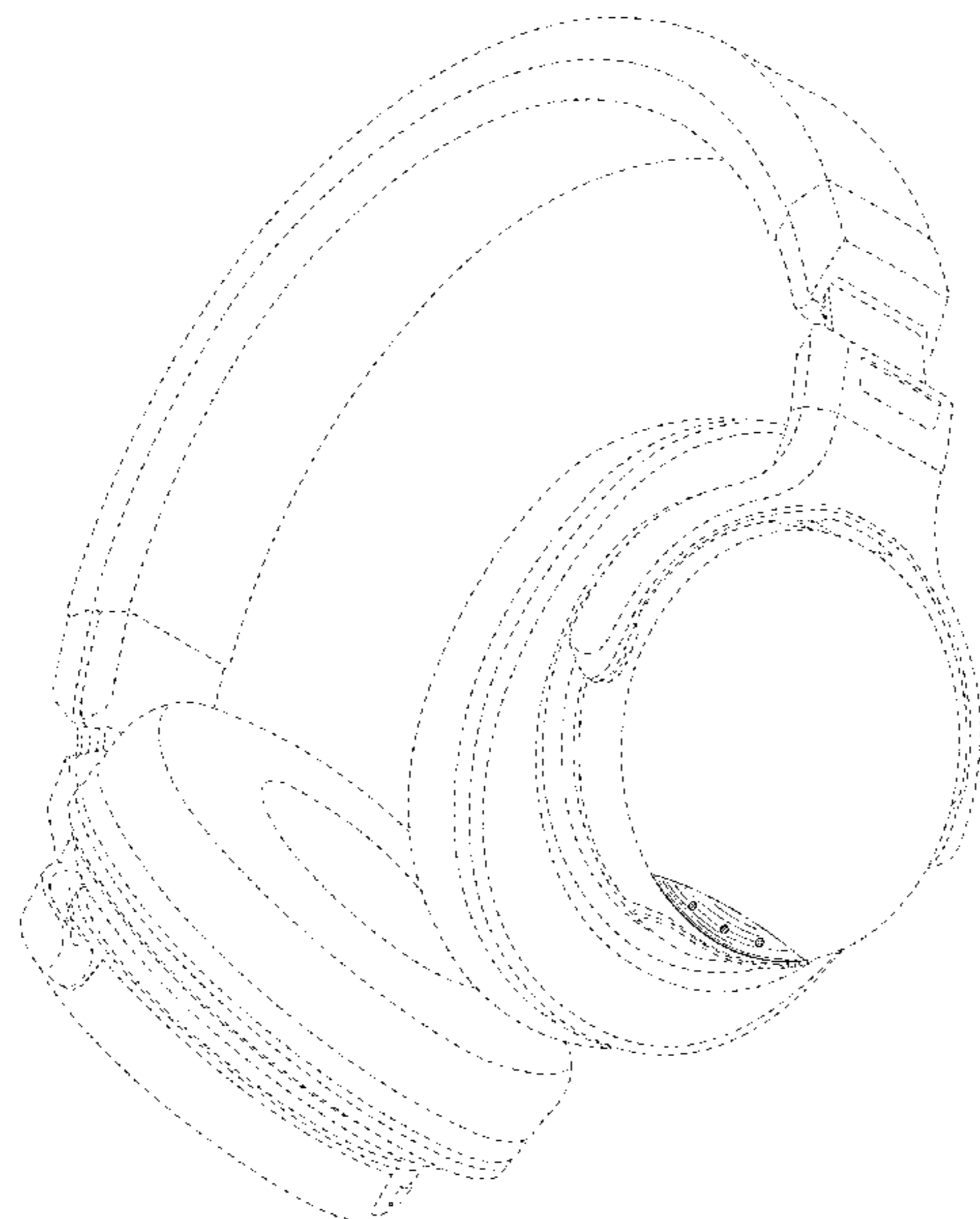
We claim the ornamental design for a headphone, as shown and described.

**DESCRIPTION**

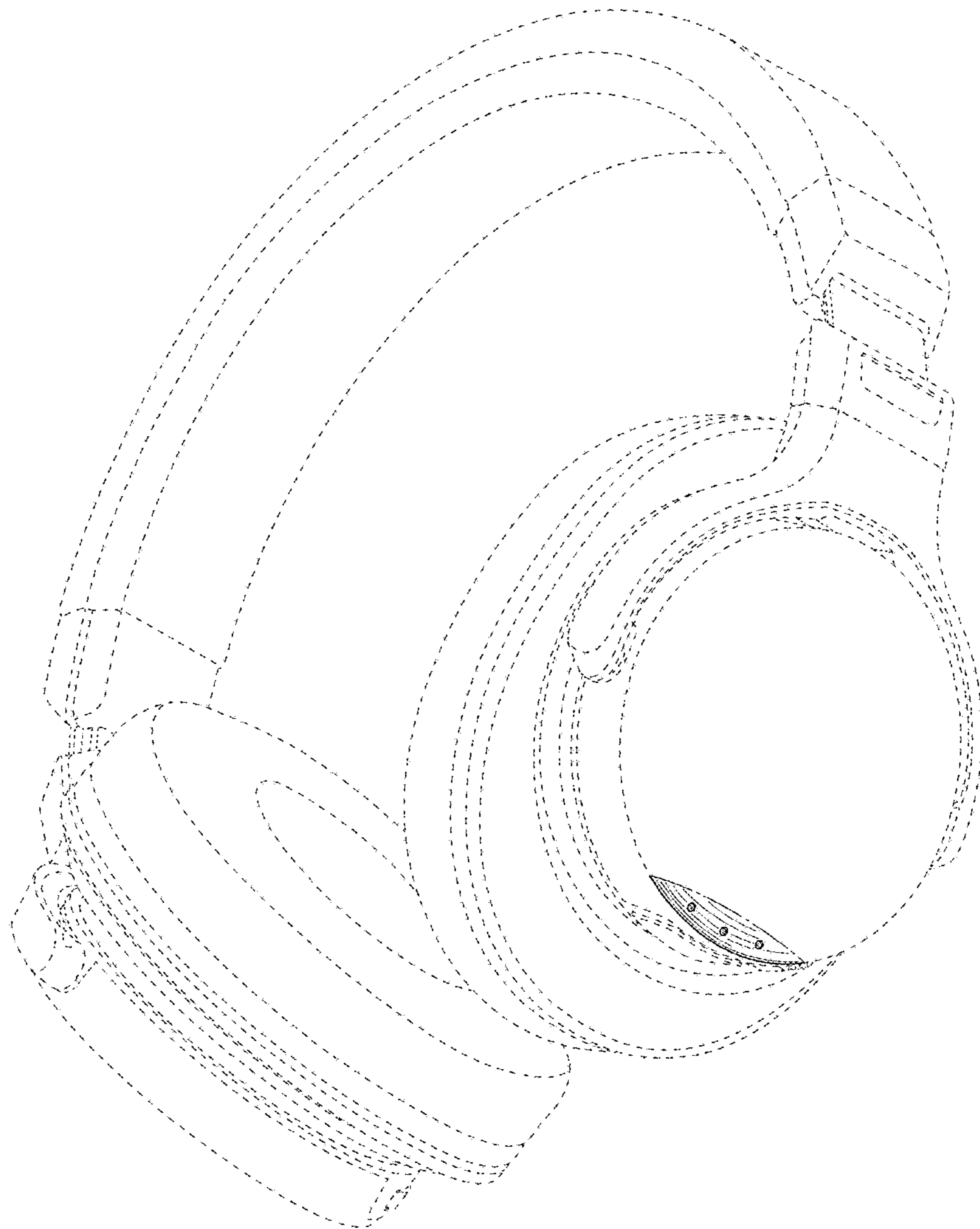
FIG. 1 is a perspective view of a headphone;  
FIG. 2 is a front elevational view of the headphone;  
FIG. 3 is a rear elevational view of the headphone;  
FIG. 4 is a bottom plan view of the headphone;  
FIG. 5 is a right side elevational view of the headphone; and,  
FIG. 6 is an enlarged partial view of the headphone taken from FIG. 5.

The broken lines immediately adjacent the shaded areas represent the bounds of the claimed design while all other broken lines are directed to environment that forms no part of the claimed design.

**1 Claim, 6 Drawing Sheets**



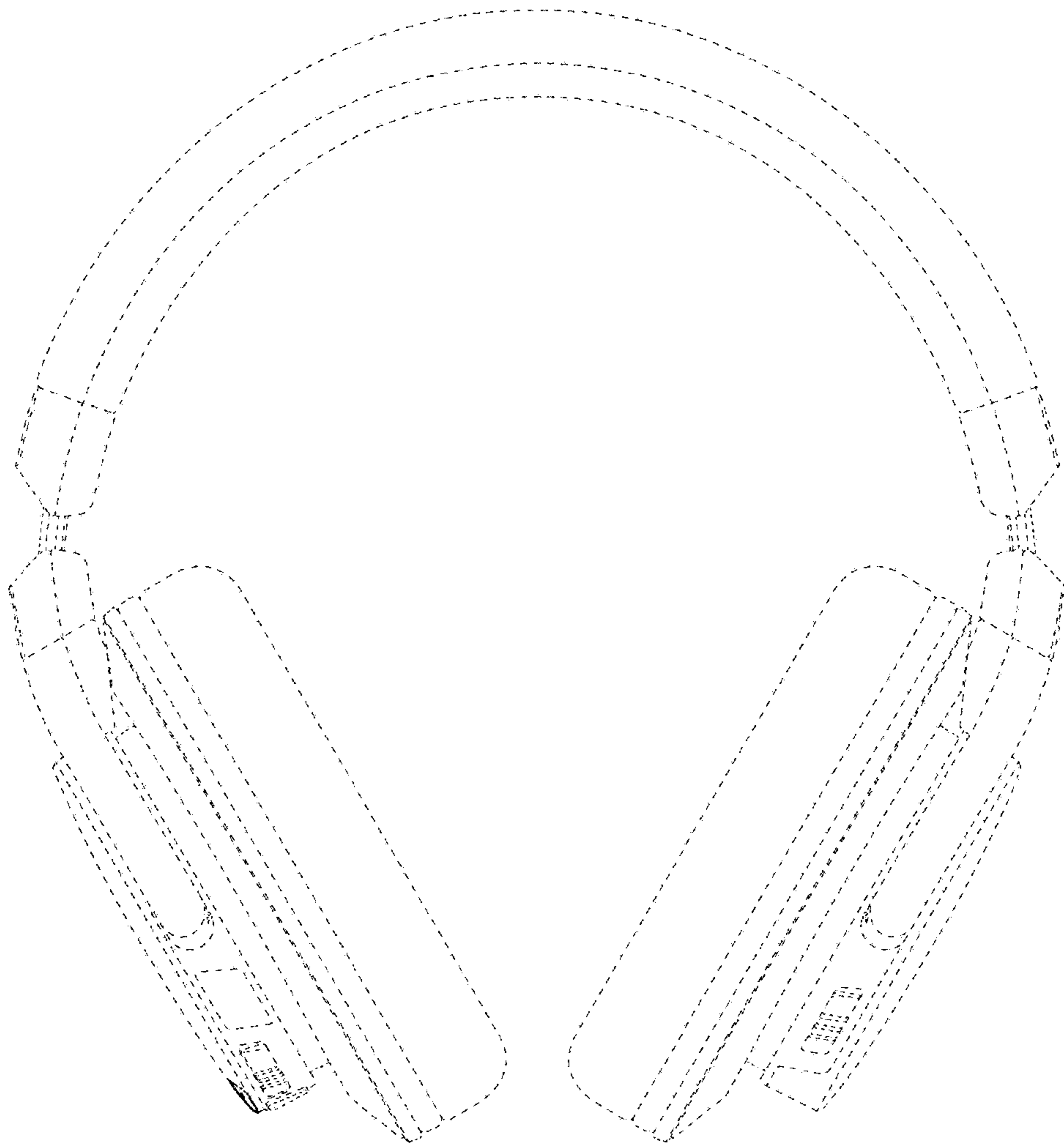
**FIG. 1**



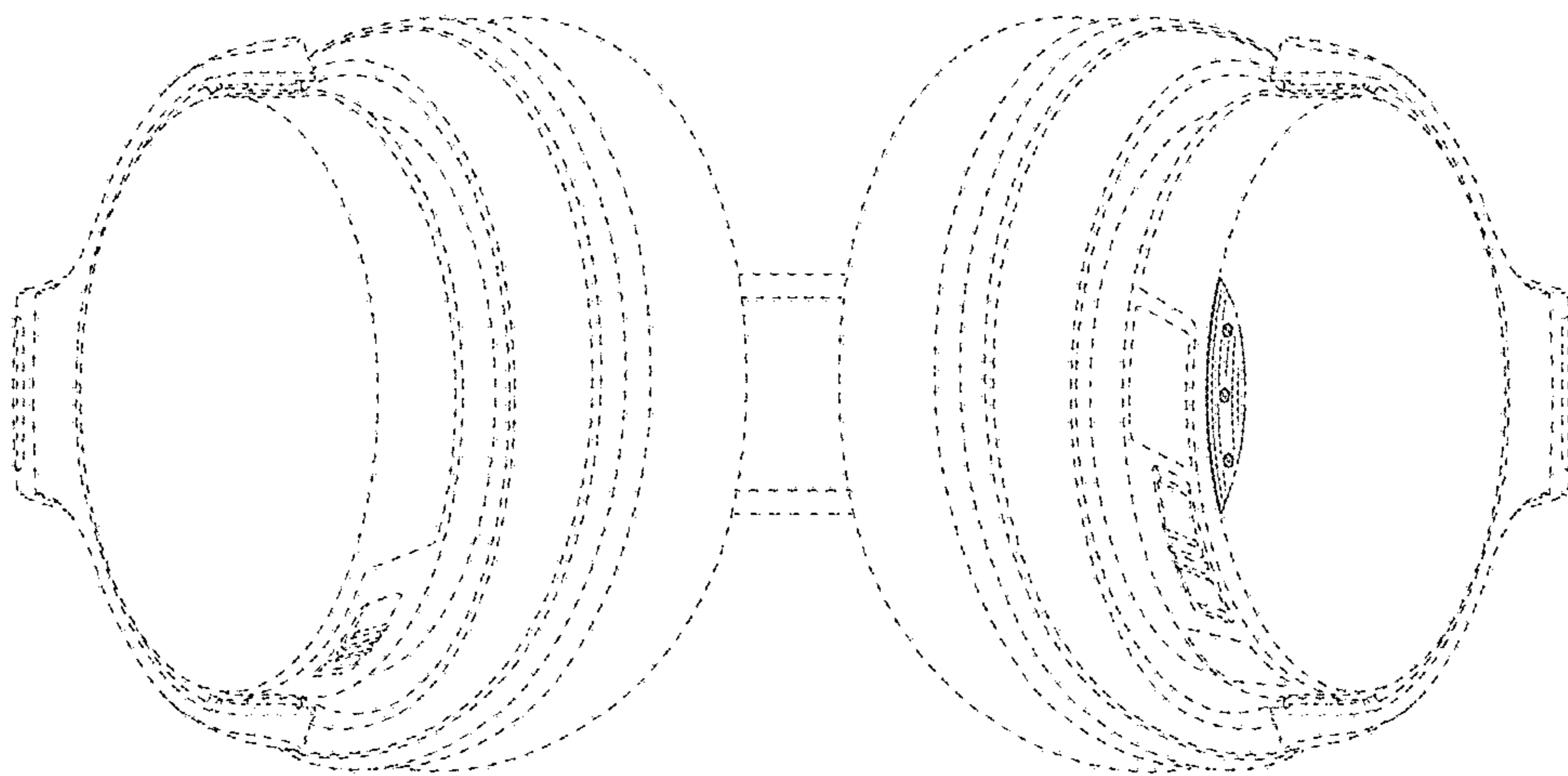
**FIG. 2**



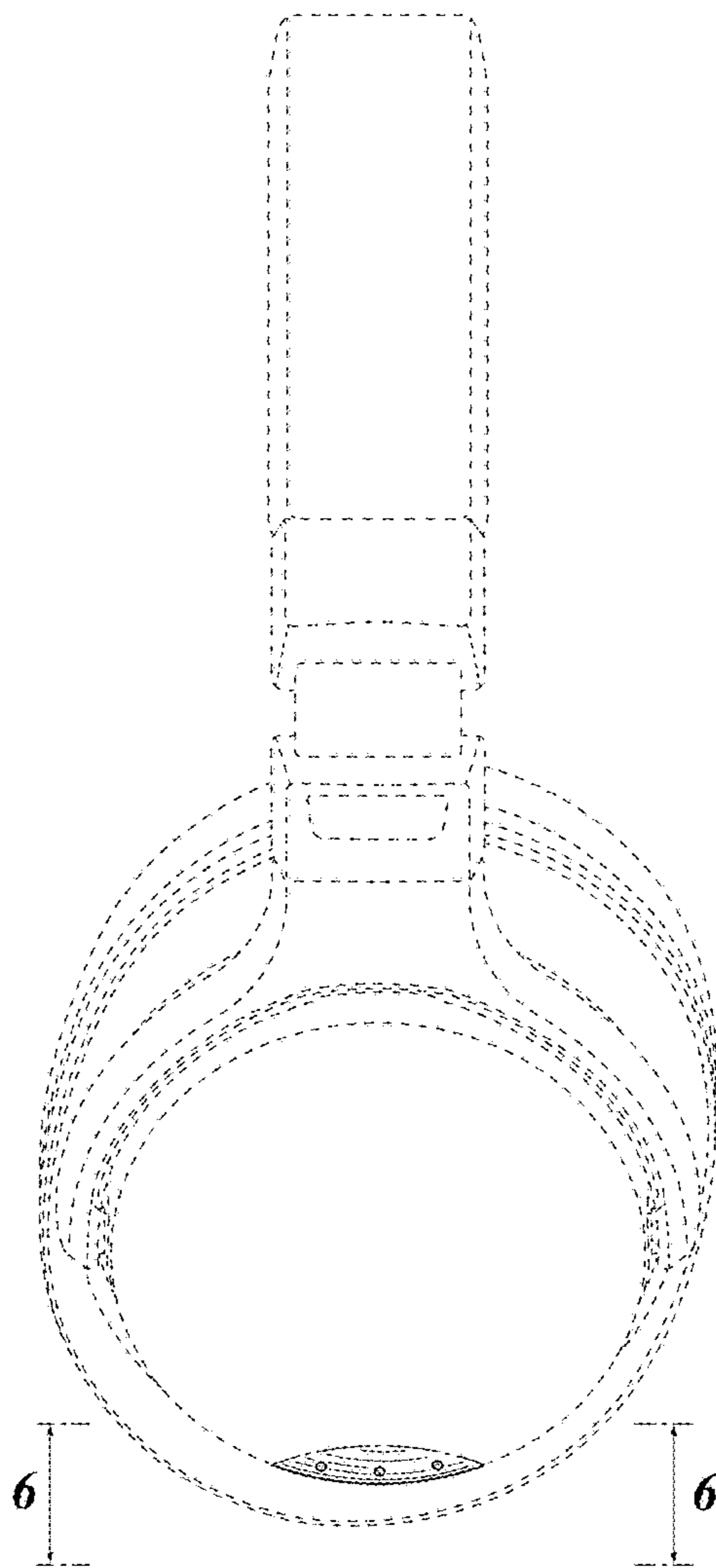
**FIG. 3**



**FIG. 4**



**FIG. 5**



**FIG. 6**

